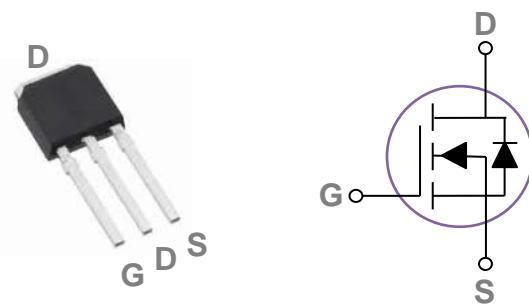


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO251 Pin Configuration



BVDSS	RDSON	ID
60V	85mΩ	10A

### Features

- 60V, 10A,  $RDS(ON) = 85m\Omega @ VGS = 10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Motor Drive
- Power Tools
- LED Lighting

### Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ C$ )	10	A
	Drain Current – Continuous ( $T_c=100^\circ C$ )	6.4	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	40	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	9	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	13.5	A
$P_D$	Power Dissipation ( $T_c=25^\circ C$ )	24	W
	Power Dissipation – Derate above 25°C	0.19	W/ $^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	5.25	$^\circ C/W$

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	60	---	---	V
$\text{I}_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=60\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=48\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

**On Characteristics**

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=3\text{A}$	---	71	85	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=2\text{A}$	---	80	104	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D = 250\mu\text{A}$	1.2	1.6	2.5	V
$\text{gfs}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_D=1\text{A}$	---	3	---	S

**Dynamic and switching Characteristics**

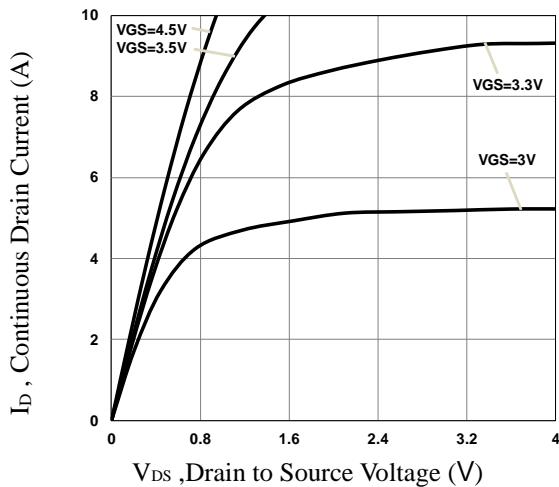
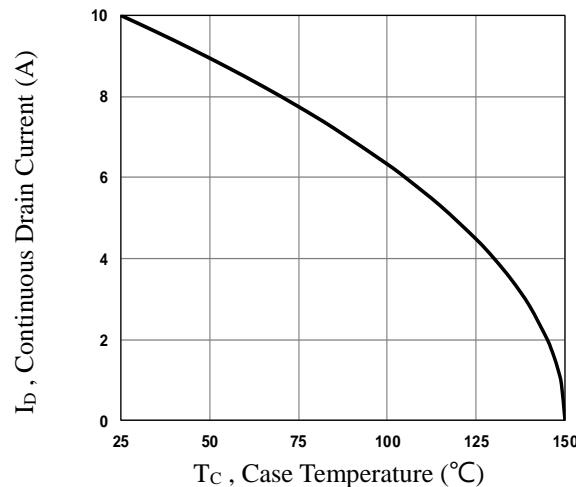
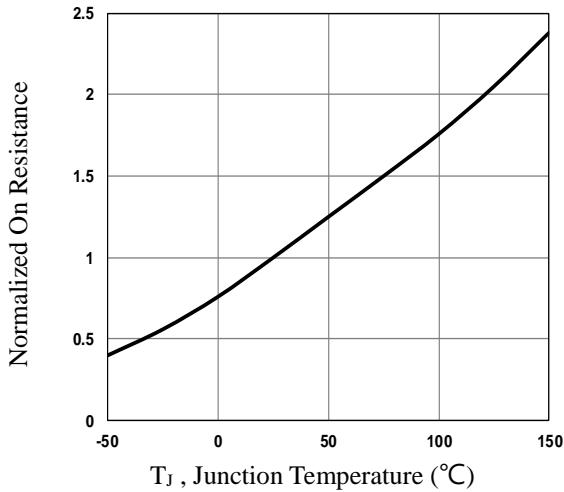
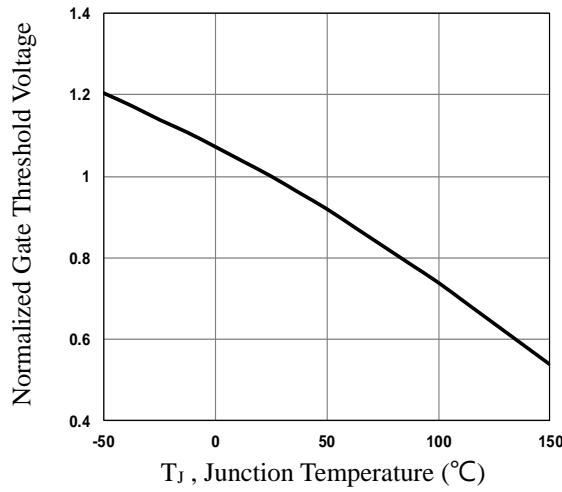
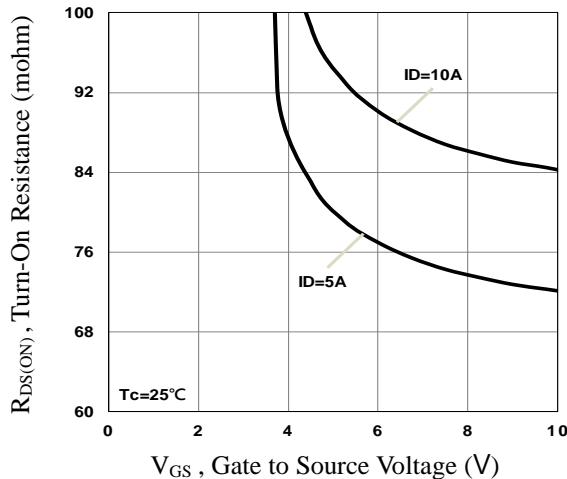
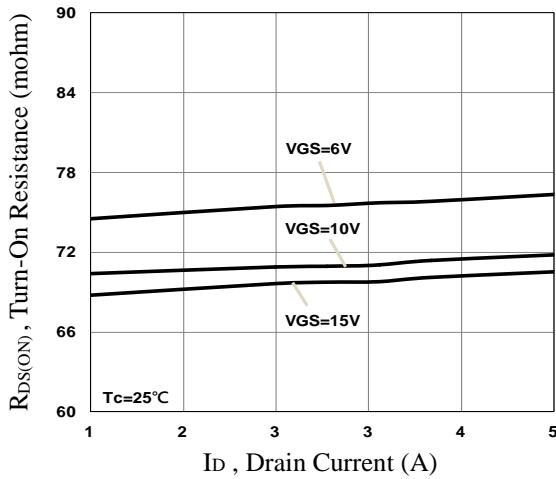
$Q_g$	Total Gate Charge <sup>2, 3</sup>	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=5\text{A}$	---	5.7	9	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>2, 3</sup>		---	0.5	2.5	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>2, 3</sup>		---	1.9	3	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>2, 3</sup>	$V_{\text{DD}}=30\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=6\Omega$ $I_D=5\text{A}$	---	5.2	8	ns
$T_r$	Rise Time <sup>2, 3</sup>		---	6.8	10	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>2, 3</sup>		---	14.5	22	
$T_f$	Fall Time <sup>2, 3</sup>		---	2.1	4	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	450	675	pF
$C_{\text{oss}}$	Output Capacitance		---	25	38	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	19	30	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	2	---	$\Omega$

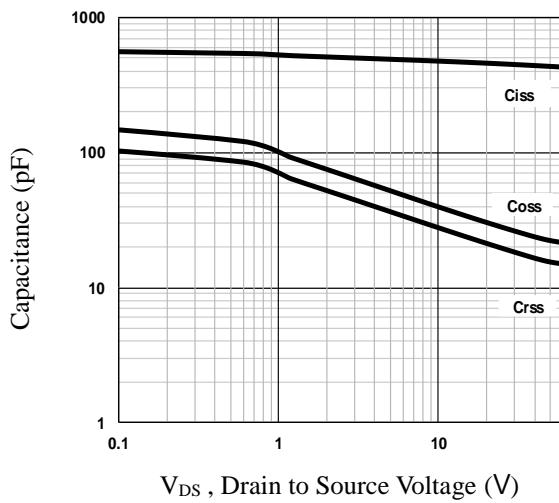
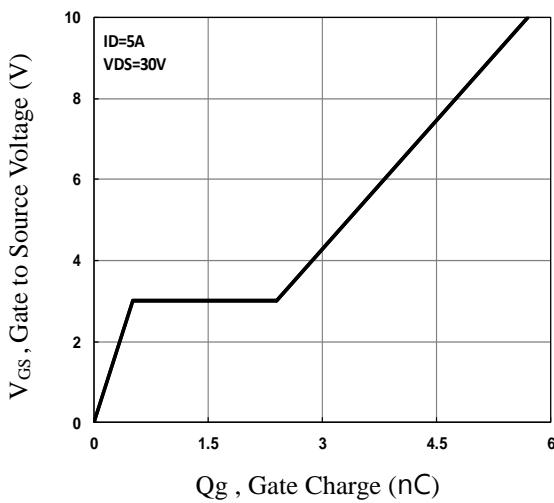
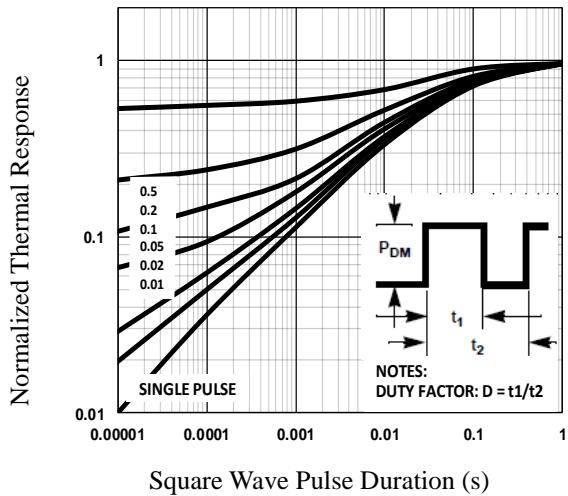
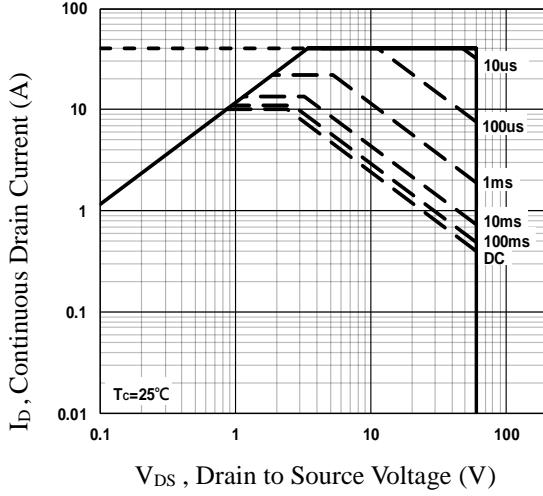
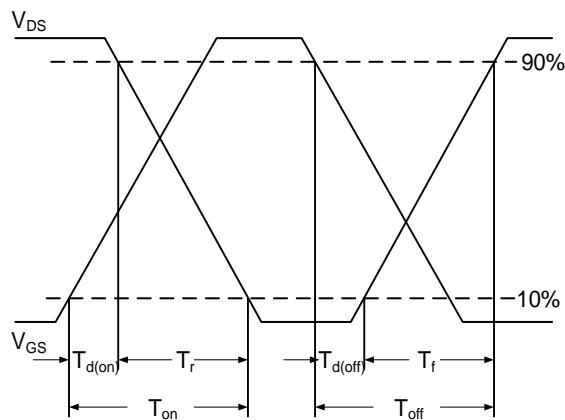
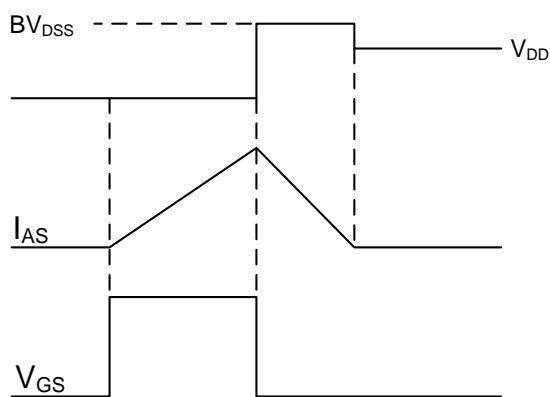
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	10	A
			---	---	20	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V
$t_{\text{rr}}$	Reverse Recovery Time <sup>2</sup>	$V_R=50\text{V}$ , $I_s=10\text{A}$ $dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	20	---	ns
$Q_{\text{rr}}$	Reverse Recovery Charge <sup>2</sup>		---	10	---	nC

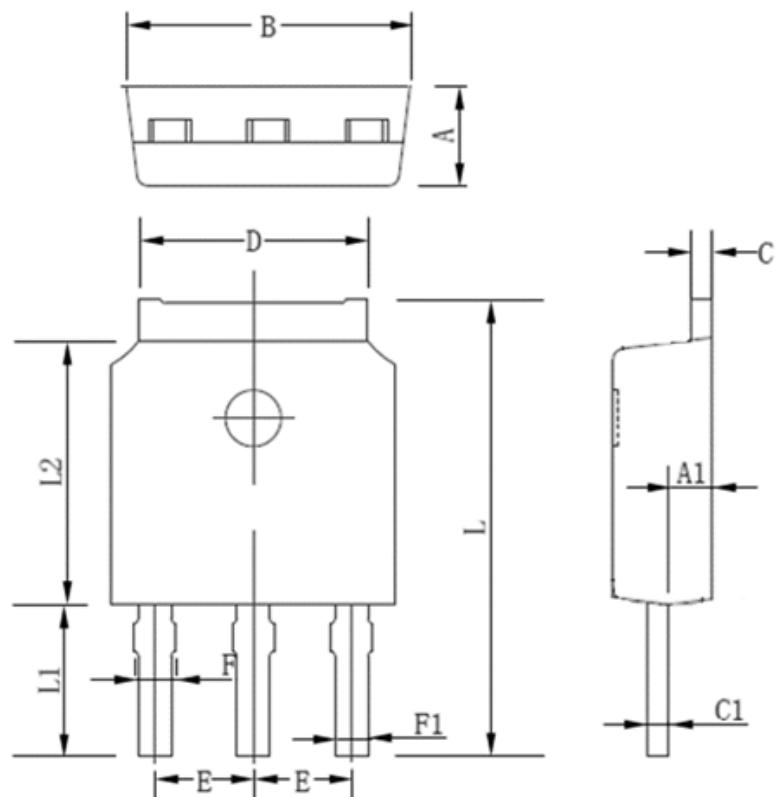
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=13.5\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Typical Output Characteristics**

**Fig.2 Continuous Drain Current vs.  $T_c$** 

**Fig.3 Normalized  $R_{DSON}$  vs.  $T_j$** 

**Fig.4 Normalized  $V_{th}$  vs.  $T_j$** 

**Fig.5 Turn-On Resistance vs.  $V_{GS}$** 

**Fig.6 Turn-On Resistance vs.  $I_D$**


**Fig.7 Capacitance Characteristics**

**Fig.8 Gate Charge Characteristics**

**Fig.9 Normalized Transient Impedance**

**Fig.10 Maximum Safe Operation Area**

**Fig.11 Switching Time Waveform**

**Fig.12 EAS Waveform**

## TO251 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.500	2.100	0.098	0.083
A1	1.250	0.900	0.049	0.035
B	6.800	6.400	0.268	0.252
C	0.580	0.420	0.023	0.017
C1	0.580	0.420	0.023	0.017
D	5.530	5.000	0.218	0.197
E	2.400	2.000	0.094	0.079
F	1.050	0.600	0.041	0.024
F1	0.900	0.500	0.035	0.020
L	12.400	9.600	0.488	0.378
L1	5.300	3.800	0.209	0.150
L2	6.400	5.700	0.252	0.224